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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

E·XF

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	UART/USART, USB
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	23
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf2450t-i-ml

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2.2.3 EXTERNAL CLOCK INPUT

The EC, ECIO, ECPLL and ECPIO Oscillator modes require an external clock source to be connected to the OSC1 pin. There is no oscillator start-up time required after a Power-on Reset or after an exit from Sleep mode.

In the EC and ECPLL Oscillator modes, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 2-4 shows the pin connections for the EC Oscillator mode.



The ECIO and ECPIO Oscillator modes function like the EC and ECPLL modes, except that the OSC2 pin becomes an additional general purpose I/O pin. The I/O pin becomes bit 6 of PORTA (RA6). Figure 2-5 shows the pin connections for the ECIO Oscillator mode.

FIGURE 2-5: EXTERNAL CLOCK INPUT OPERATION (ECIO AND ECPIO CONFIGURATION)



The internal postscaler for reducing clock frequency in XT and HS modes is also available in EC and ECIO modes.

2.2.4 PLL FREQUENCY MULTIPLIER

PIC18F2450/4450 devices include a Phase Locked Loop (PLL) circuit. This is provided specifically for USB applications with lower speed oscillators and can also be used as a microcontroller clock source.

The PLL is enabled in HSPLL, XTPLL, ECPLL and ECPIO Oscillator modes. It is designed to produce a fixed 96 MHz reference clock from a fixed 4 MHz input. The output can then be divided and used for both the USB and the microcontroller core clock. Because the PLL has a fixed frequency input and output, there are eight prescaling options to match the oscillator input frequency to the PLL.

There is also a separate postscaler option for deriving the microcontroller clock from the PLL. This allows the USB peripheral and microcontroller to use the same oscillator input and still operate at different clock speeds. In contrast to the postscaler for XT, HS and EC modes, the available options are 1/2, 1/3, 1/4 and 1/6 of the PLL output.

The HSPLL, ECPLL and ECPIO modes make use of the HS mode oscillator for frequencies up to 48 MHz. The prescaler divides the oscillator input by up to 12 to produce the 4 MHz drive for the PLL. The XTPLL mode can only use an input frequency of 4 MHz which drives the PLL directly.

FIGURE 2-6: PLL BLOCK DIAGRAM (HS MODE)



Input Oscillator Frequency	PLL Division (PLLDIV2:PLLDIV0)	Clock Mode (FOSC3:FOSC0)	MCU Clock Division (CPUDIV1:CPUDIV0)	Microcontroller Clock Frequency
			None (00)	48 MHz
40 MUL	N/(A(1)		÷2(01)	24 MHz
	N/A ^(*)	EC, ECIO	÷3(10)	16 MHz
			÷4 (11)	12 MHz
			None (00)	48 MHz
			÷2(01)	24 MHz
		EC, ECIU	÷3(10)	16 MHz
40 MU-	· 12 (111)		÷4 (11)	12 MHz
40 MITZ	÷12(111)		÷2 (00)	48 MHz
			÷3(01)	32 MHz
		EGPLL, EGPIO	÷4 (10)	24 MHz
			÷6(11)	16 MHz
			None (00)	40 MHz
			÷2(01)	20 MHz
		EC, ECIU	÷3(10)	13.33 MHz
40 MU-	. 10 (110)		÷4 (11)	10 MHz
	÷10(110)	ECPLL, ECPIO	÷2 (00)	48 MHz
			÷3(01)	32 MHz
			÷4 (10)	24 MHz
			÷6(11)	16 MHz
	÷6 (101)	HS, EC, ECIO	None (00)	24 MHz
			÷2(01)	12 MHz
			÷3(10)	8 MHz
24 MHz			÷4 (11)	6 MHz
24 1011 12		HSPLL, ECPLL, ECPIO	÷2 (00)	48 MHz
			÷3(01)	32 MHz
			÷4 (10)	24 MHz
			÷6(11)	16 MHz
			None (00)	20 MHz
			÷2(01)	10 MHz
		113, EC, ECIO	÷3(10)	6.67 MHz
20 MHz	.5 (100)		÷4 (11)	5 MHz
20 10112	÷5 (100)		÷2 (00)	48 MHz
			÷3(01)	32 MHz
		HOPLL, ECPLL, ECFIC	÷4 (10)	24 MHz
			÷6 (11)	16 MHz
			None (00)	16 MHz
16 MUS			÷2 (01)	8 MHz
	÷4 (011)	110, LO, EOIO	÷3 (10)	5.33 MHz
			÷4 (11)	4 MHz
			÷2 (00)	48 MHz
			÷3(01)	32 MHz
		I ISFLL, EGPLL, EGPIO	÷4 (10)	24 MHz
			÷6 (11)	16 MHz

TABLE 2-3: OSCILLATOR CONFIGURATION OPTIONS FOR USB OPERATION

Legend: All clock frequencies, except 24 MHz, are exclusively associated with full-speed USB operation (USB clock of 48 MHz). Bold is used to highlight clock selections that are compatible with low-speed USB operation (system clock of 24 MHz, USB clock of 6 MHz).

Note 1: Only valid when the USBDIV Configuration bit is cleared.

5.2.3 INSTRUCTIONS IN PROGRAM MEMORY

The program memory is addressed in bytes. Instructions are stored as two bytes or four bytes in program memory. The Least Significant Byte of an instruction word is always stored in a program memory location with an even address (LSb = 0). To maintain alignment with instruction boundaries, the PC increments in steps of 2 and the LSb will always read '0' (see Section 5.1.1 "Program Counter").

Figure 5-4 shows an example of how instruction words are stored in the program memory.

The CALL and GOTO instructions have the absolute program memory address embedded into the instruction. Since instructions are always stored on word boundaries, the data contained in the instruction is a word address. The word address is written to PC<20:1>, which accesses the desired byte address in program memory. Instruction #2 in Figure 5-4 shows how the instruction, GOTO 0006h, is encoded in the program memory. Program branch instructions, which encode a relative address offset, operate in the same manner. The offset value stored in a branch instruction represents the number of single-word instructions that the PC will be offset by. Section 19.0 "Instruction Set Summary" provides further details of the instruction set.

			LSB = 1	LSB = 0	Word Address \downarrow
	Program N	lemory			000000h
	Byte Locat	ions \rightarrow			000002h
					000004h
					000006h
Instruction 1:	MOVLW	055h	0Fh	55h	000008h
Instruction 2:	GOTO	0006h	EFh	03h	00000Ah
			F0h	00h	00000Ch
Instruction 3:	MOVFF	123h, 456h	C1h	23h	00000Eh
			F4h	56h	000010h
					000012h
					000014h

FIGURE 5-4: INSTRUCTIONS IN PROGRAM MEMORY

5.2.4 TWO-WORD INSTRUCTIONS

The standard PIC18 instruction set has four two-word instructions: CALL, MOVFF, GOTO and LSFR. In all cases, the second word of the instructions always has '1111' as its four Most Significant bits; the other 12 bits are literal data, usually a data memory address.

The use of '1111' in the 4 MSbs of an instruction specifies a special form of NOP. If the instruction is executed in proper sequence, immediately after the first word, the data in the second word is accessed and

used by the instruction sequence. If the first word is skipped for some reason and the second word is executed by itself, a NOP is executed instead. This is necessary for cases when the two-word instruction is preceded by a conditional instruction that changes the PC. Example 5-4 shows how this works.

Note:	See Section 5.5 "Program Memory and
	the Extended Instruction Set" for
	information on two-word instruction in the
	extended instruction set.

EXAMPLE 5-4:	TWO-WORD INSTRUCTIONS
--------------	-----------------------

CASE 1:	
Object Code	Source Code
0110 0110 0000 0000	TSTFSZ REG1 ; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2 ; No, skip this word
1111 0100 0101 0110	; Execute this word as a NOP
0010 0100 0000 0000	ADDWF REG3 ; continue code
CASE 2:	
Object Code	Source Code
0110 0110 0000 0000	TSTFSZ REG1 ; is RAM location 0?
1100 0001 0010 0011	MOVFF REG1, REG2 ; Yes, execute this word
1111 0100 0101 0110	; 2nd word of instruction
0010 0100 0000 0000	ADDWF REG3 ; continue code

6.3 Reading the Flash Program Memory

The TBLRD instruction is used to retrieve data from program memory and places it into data RAM. Table reads from program memory are performed one byte at a time.

TBLPTR points to a byte address in program space. Executing TBLRD places the byte pointed to into TABLAT. In addition, TBLPTR can be modified automatically for the next table read operation.

The internal program memory is typically organized by words. The Least Significant bit of the address selects between the high and low bytes of the word. Figure 6-4 shows the interface between the internal program memory and the TABLAT.

FIGURE 6-4: READS FROM FLASH PROGRAM MEMORY



EXAMPLE 6-1: READING A FLASH PROGRAM MEMORY WORD

READ WORD	MOVLW MOVWF MOVUW MOVWF MOVLW MOVWF	CODE_ADDR_UPPER TBLPTRU CODE_ADDR_HIGH TBLPTRH CODE_ADDR_LOW TBLPTRL	; Load TBLPTR with the base ; address of the word	
	TBLRD*+ MOVF MOVWF TBLRD*+ MOVF MOVF	TABLAT, W WORD_EVEN TABLAT, W WORD_ODD	; read into TABLAT and increment ; get data ; read into TABLAT and increment ; get data	

7.0 8 x 8 HARDWARE MULTIPLIER

7.1 Introduction

All PIC18 devices include an 8 x 8 hardware multiplier as part of the ALU. The multiplier performs an unsigned operation and yields a 16-bit result that is stored in the product register pair, PRODH:PRODL. The multiplier's operation does not affect any flags in the STATUS register.

Making multiplication a hardware operation allows it to be completed in a single instruction cycle. This has the advantages of higher computational throughput and reduced code size for multiplication algorithms and allows the PIC18 devices to be used in many applications previously reserved for digital signal processors. A comparison of various hardware and software multiply operations, along with the savings in memory and execution time, is shown in Table 7-1.

7.2 Operation

Example 7-1 shows the instruction sequence for an 8 x 8 unsigned multiplication. Only one instruction is required when one of the arguments is already loaded in the WREG register.

Example 7-2 shows the sequence to do an 8 x 8 signed multiplication. To account for the sign bits of the arguments, each argument's Most Significant bit (MSb) is tested and the appropriate subtractions are done.

EXAMPLE 7-1: 8 x 8 UNSIGNED MULTIPLY ROUTINE

MOVF ARG1, W ; MULWF ARG2 ; ARG1 * ARG2 -> ; PRODH:PRODL
--

EXAMPLE 7-2: 8 x 8 SIGNED MULTIPLY

		ROUTINE	
MOVF	ARG1, W		
MULWF	ARG2	; ARG1 * ARG2 ->	
		; PRODH:PRODL	
BTFSC	ARG2, SB	; Test Sign Bit	
SUBWF	PRODH, F	; PRODH = PRODH	
		; – ARG1	
MOVF	ARG2, W		
BTFSC	ARG1, SB	; Test Sign Bit	
SUBWF	PRODH, F	; PRODH = PRODH	
		; – ARG2	

		Program	Cycles	Time		
Routine	Multiply Method	Memory (Words)	(Max)	@ 40 MHz	@ 10 MHz	@ 4 MHz
8 x 8 unsigned	Without hardware multiply	13	69	6.9 μs	27.6 μs	69 μs
o x o unsigned	Hardware multiply	1	1	100 ns	400 ns	1 μs
8 x 8 signed	Without hardware multiply	33	91	9.1 μs	36.4 μs	91 μs
	Hardware multiply	6	6	600 ns	2.4 μs	6 μ s
16 x 16 uppigned	Without hardware multiply	21	242	24.2 μs	96.8 μs	242 μs
To x To unsigned	Hardware multiply	28	28	2.8 μs	11.2 μs	28 μs
16 x 16 signed	Without hardware multiply	52	254	25.4 μs	102.6 μs	254 μs
	Hardware multiply	35	40	4.0 μs	16.0 μs	40 μs

TABLE 7-1: PERFORMANCE COMPARISON FOR VARIOUS MULTIPLY OPERATIONS

8.2 INTCON Registers

The INTCON registers are readable and writable registers which contain various enable, priority and flag bits.

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

REGISTER 8-1: INTCON: INTERRUPT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF ⁽¹⁾
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	GIE/GIEH: Global Interrupt Enable bit <u>When IPEN = 0:</u> 1 = Enables all unmasked interrupts 0 = Disables all interrupts <u>When IPEN = 1:</u> 1 = Enables all high-priority interrupts 0 = Disables all interrupts
bit 6	 Disables all interrupts PEIE/GIEL: Peripheral Interrupt Enable bit <u>When IPEN = 0:</u> 1 = Enables all unmasked peripheral interrupts 0 = Disables all peripheral interrupts
	<u>When IPEN = 1:</u> 1 = Enables all low-priority peripheral interrupts 0 = Disables all low-priority peripheral interrupts
bit 5	TMR0IE: TMR0 Overflow Interrupt Enable bit 1 = Enables the TMR0 overflow interrupt 0 = Disables the TMR0 overflow interrupt
bit 4	INTOIE: INTO External Interrupt Enable bit 1 = Enables the INTO external interrupt 0 = Disables the INTO external interrupt
bit 3	RBIE: RB Port Change Interrupt Enable bit 1 = Enables the RB port change interrupt 0 = Disables the RB port change interrupt
bit 2	TMR0IF: TMR0 Overflow Interrupt Flag bit 1 = TMR0 register has overflowed (must be cleared in software) 0 = TMR0 register did not overflow
bit 1	INTOIF: INTO External Interrupt Flag bit 1 = The INTO external interrupt occurred (must be cleared in software) 0 = The INTO external interrupt did not occur
bit 0	RBIF: RB Port Change Interrupt Flag bit ⁽¹⁾ 1 = At least one of the RB7:RB4 pins changed state (must be cleared in software) 0 = None of the RB7:RB4 pins have changed state
N	

Note 1: A mismatch condition will continue to set this bit. Reading PORTB and waiting 1 TCY will end the mismatch condition and allow the bit to be cleared.

8.7 INTx Pin Interrupts

External interrupts on the RB0/AN12/INT0, RB1/AN10/ INT1and RB2/AN8/INT2/VMO pins are edge-triggered. If the corresponding INTEDGx bit in the INTCON2 register is set (= 1), the interrupt is triggered by a rising edge; if the bit is clear, the trigger is on the falling edge. When a valid edge appears on the RBx/INTx pin, the corresponding flag bit, INTxIF, is set. This interrupt can be disabled by clearing the corresponding enable bit, INTxIE. Flag bit, INTxIF, must be cleared in software in the Interrupt Service Routine before re-enabling the interrupt.

All external interrupts (INT0, INT1 and INT2) can wakeup the processor from the power-managed modes if bit, INTxIE, was set prior to going into the power-managed modes. If the Global Interrupt Enable bit, GIE, is set, the processor will branch to the interrupt vector following wake-up.

Interrupt priority for INT1 and INT2 is determined by the value contained in the interrupt priority bits, INT1IP (INTCON3<6>) and INT2IP (INTCON3<7>). There is no priority bit associated with INT0. It is always a high-priority interrupt source.

8.8 TMR0 Interrupt

In 8-bit mode (which is the default), an overflow in the TMR0 register (FFh \rightarrow 00h) will set flag bit, TMR0IF. In 16-bit mode, an overflow in the TMR0H:TMR0L register pair (FFFFh \rightarrow 0000h) will set TMR0IF. The interrupt can be enabled/disabled by setting/clearing enable bit, TMR0IE (INTCON<5>). Interrupt priority for Timer0 is determined by the value contained in the interrupt priority bit, TMR0IP (INTCON2<2>). See Section 12.0 "Timer2 Module" for further details on the Timer0 module.

8.9 PORTB Interrupt-on-Change

An input change on PORTB<7:4> sets flag bit, RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit, RBIE (INTCON<3>). Interrupt priority for PORTB interrupt-on-change is determined by the value contained in the interrupt priority bit, RBIP (INTCON2<0>).

8.10 Context Saving During Interrupts

During interrupts, the return PC address is saved on the stack. Additionally, the WREG, STATUS and BSR registers are saved on the Fast Return Stack. If a fast return from interrupt is not used (see **Section 5.3 "Data Memory Organization"**), the user may need to save the WREG, STATUS and BSR registers on entry to the Interrupt Service Routine. Depending on the user's application, other registers may also need to be saved. Example 8-1 saves and restores the WREG, STATUS and BSR registers during an Interrupt Service Routine.

MOVWF	W_TEMP	; W_TEMP is in virtual bank	
MOVFF	STATUS, STATUS_TEMP	; STATUS_TEMP located anywhere	
MOVFF	BSR, BSR_TEMP	; BSR_TMEP located anywhere	
;			
; USER	ISR CODE		

; Restore BSR

; Restore WREG

; Restore STATUS

EXAMPLE 8-1: SAVING STATUS, WREG AND BSR REGISTERS IN RAM

; ; USER ISR CODE ; MOVFF BSR_TEMP, BSR MOVF W_TEMP, W MOVFF STATUS TEMP, STATUS

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Pin	Function	TRIS Setting	I/O	I/О Туре	Description				
RA0/AN0	RA0	0	OUT	DIG	LATA<0> data output; not affected by analog input.				
		1	IN	TTL	PORTA<0> data input; disabled when analog input enabled.				
	AN0	1	IN	ANA	A/D input channel 0. Default configuration on POR; does not affect digital output.				
RA1/AN1	RA1 0 OUT DIG LATA<1> data output; not affected by analog input.				LATA<1> data output; not affected by analog input.				
		1	IN	TTL	PORTA<1> data input; reads '0' on POR.				
	AN1	1	IN	ANA	A/D input channel 1. Default configuration on POR; does not affect digital output.				
RA2/AN2/	RA2	0	OUT	DIG	LATA<2> data output; not affected by analog input.				
VREF-		1	IN	TTL	PORTA<2> data input. Disabled when analog functions enabled.				
	AN2	1	IN	ANA	A/D input channel 2. Default configuration on POR; not affected by analog output.				
	VREF-	1	IN	ANA	A/D voltage reference low input.				
RA3/AN3/	RA3	0	OUT	DIG	LATA<3> data output; not affected by analog input.				
VREF+		1	IN	TTL	PORTA<3> data input; disabled when analog input enabled.				
	AN3	1	IN	ANA	A/D input channel 3. Default configuration on POR.				
	VREF+	1	IN	ANA	A/D voltage reference high input.				
RA4/T0CKI/	RA4	0	OUT	DIG	LATA<4> data output; not affected by analog input.				
RCV		1	IN	ST	PORTA<4> data input; disabled when analog input enabled.				
	T0CKI	1	IN	ST	Timer0 clock input.				
	RCV	х	IN	TTL	External USB transceiver RCV input.				
RA5/AN4/	RA5	0	OUT	DIG	LATA<5> data output; not affected by analog input.				
HLVDIN		1	IN	TTL	PORTA<5> data input; disabled when analog input enabled.				
	AN4	1	IN	ANA	A/D input channel 4. Default configuration on POR.				
	HLVDIN	1	IN	ANA	High/Low-Voltage Detect external trip point input.				
OSC2/CLKO/	OSC2	х	OUT	ANA	Main oscillator feedback output connection (all XT and HS modes).				
RA6	CLKO	Х	OUT	DIG	System cycle clock output (Fosc/4); available in EC, ECPLL and INTCKO modes.				
	RA6	0	OUT	DIG	LATA<6> data output. Available only in ECIO, ECPIO and INTIO modes; otherwise, reads as '0'.				
		1	IN	TTL	PORTA<6> data input. Available only in ECIO, ECPIO and INTIO modes; otherwise, reads as '0'.				

TABLE 9-1: PORTA I/O SUMMARY

Legend: OUT = Output, IN = Input, ANA = Analog Signal, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option)

TABLE 9-2:	SUMMARY OF REGISTERS ASSOCIATED WITH PORT	Δ
	COMMANY OF RECIDIENC ACCOUNTED WITH FORM	~

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
PORTA		RA6 ⁽¹⁾	RA5	RA4	RA3	RA2	RA1	RA0	51
LATA	—	LATA6 ⁽¹⁾	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	51
TRISA	—	TRISA6 ⁽¹⁾	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	51
ADCON1	—	_	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	50
UCON	_	PPBRST	SE0	PKTDIS	USBEN	RESUME	SUSPND	_	52

Legend: — = unimplemented, read as '0'. Shaded cells are not used by PORTA.

Note 1: RA6 and its associated latch and data direction bits are enabled as I/O pins based on oscillator configuration; otherwise, they are read as '0'.

9.2 PORTB, TRISB and LATB Registers

PORTB is an 8-bit wide, bidirectional port. The corresponding Data Direction register is TRISB. Setting a TRISB bit (= 1) will make the corresponding PORTB pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISB bit (= 0) will make the corresponding PORTB pin an output (i.e., put the contents of the output latch on the selected pin).

The Output Latch register (LATB) is also memory mapped. Read-modify-write operations on the LATB register read and write the latched output value for PORTB.

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit, RBPU (INTCON2<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset.

Note:	On a Power-on Reset, RB4:RB0 are configured as analog inputs by default and read as '0'; RB7:RB5 are configured as digital inputs.
	By programming the Configuration bit, PBADEN (CONFIG3H<1>), RB4:RB0 will alternatively be configured as digital inputs on POR.

Four of the PORTB pins (RB7:RB4) have an interrupton-change feature. Only pins configured as inputs can cause this interrupt to occur. Any RB7:RB4 pin configured as an output is excluded from the interrupton-change comparison. The pins are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are ORed together to generate the RB Port Change Interrupt with Flag bit, RBIF (INTCON<0>).

The interrupt-on-change can be used to wake the device from Sleep. The user, in the Interrupt Service Routine, can clear the interrupt in the following manner:

- a) Any read or write of PORTB (except with the MOVFF (ANY), PORTB instruction). This will end the mismatch condition.
- b) Wait one or more instruction cycles.
- c) Clear flag bit, RBIF.

A mismatch condition will continue to set flag bit, RBIF. Reading PORTB will end the mismatch condition and allow flag bit, RBIF, to be cleared.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt-on-change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

Pins, RB2 and RB3, are multiplexed with the USB peripheral and serve as the differential signal outputs for an external USB transceiver (TRIS configuration). Refer to **Section 14.2.2.2 "External Transceiver"** for additional information on configuring the USB module for operation with an external transceiver.

CLRF	PORTB	; Initialize PORTB by ; clearing output ; data latches
CLRF	LATB	<pre>; Alternate method ; to clear output ; data latches</pre>
MOVLW	0Eh	; Set RB<4:0> as
MOVWF	ADCON1	; digital I/O pins
		; (required if config bit ; PBADEN is set)
MOVLW	OCFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISB	; Set RB<3:0> as inputs ; RB<5:4> as outputs ; RB<7:6> as inputs

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		R/W-0
CSRC	TX9	TXEN ⁽¹⁾	SYNC	SENDB	BRGH	TRMT	TX9D
bit 7			1		1	.1	bit 0
Legend:							
R = Readable	e bit	W = Writable	bit	U = Unimpler	mented bit, read	l as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 7	CSRC: Clock	Source Select	bit				
	Don't care.	<u>s mode:</u>					
	<u>Synchronous</u>	mode:					
	1 = Master m	ode (clock gen	erated interna	ally from BRG)			
hit 6		ansmit Enable I	external sour				
bit o	1 = Selects 9	-bit transmissio	n				
	0 = Selects 8	-bit transmissio	n				
bit 5	TXEN: Trans	mit Enable bit ⁽¹)				
	1 = Transmit	enabled					
hit 4			ot bit				
DIL 4	1 = Synchron	ara i wode ious mode					
	0 = Asynchro	nous mode					
bit 3	SENDB: Sen	d Break Chara	cter bit				
	Asynchronou	<u>s mode:</u>		<i>,</i>			
	1 = Send Syn 0 = Sync Brea	ic Break on nex ak transmissior	kt transmission completed	n (cleared by h	ardware upon o	completion)	
	Synchronous	mode:	roompicted				
	Don't care.						
bit 2	BRGH: High	Baud Rate Sel	ect bit				
	Asynchronou	<u>s mode:</u> od					
	0 = Low spee	ed					
	Synchronous	mode:					
	Unused in thi	s mode.					
bit 1	TRMT: Trans	mit Shift Regist	er Status bit				
	1 = TSR emp 0 = TSR full	oty					
bit 0	TX9D: 9th bit	of Transmit Da	ata				
	Can be addre	ess/data bit or a	parity bit.				
			0	34h 4h			

REGISTER 15-1: TXSTA: TRANSMIT STATUS AND CONTROL REGISTER

Note 1: SREN/CREN overrides TXEN in Sync mode with the exception that SREN has no effect in Synchronous Slave mode.

BAUD RATE (K)					SYNC	= 0, BRGH	l = 0, BRC	616 = 0				
	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz		
	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)
0.3	_						_			_		
1.2	—	—	—	1.221	1.73	255	1.202	0.16	129	1.201	-0.16	103
2.4	2.441	1.73	255	2.404	0.16	129	2.404	0.16	64	2.403	-0.16	51
9.6	9.615	0.16	64	9.766	1.73	31	9.766	1.73	15	9.615	-0.16	12
19.2	19.531	1.73	31	19.531	1.73	15	19.531	1.73	7	—	_	_
57.6	56.818	-1.36	10	62.500	8.51	4	52.083	-9.58	2	—	_	_
115.2	125.000	8.51	4	104.167	-9.58	2	78.125	-32.18	1	—	_	_

TABLE 15-3: BAUD RATES FOR ASYNCHRONOUS MODES

		SYNC = 0, BRGH = 0, BRG16 = 0												
BAUD	Fos	c = 4.000	MHz	Fos	c = 2.000	MHz	Fosc = 1.000 MHz							
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)					
0.3	0.300	0.16	207	0.300	-0.16	103	0.300	-0.16	51					
1.2	1.202	0.16	51	1.201	-0.16	25	1.201	-0.16	12					
2.4	2.404	0.16	25	2.403	-0.16	12	—	_	_					
9.6	8.929	-6.99	6	—	_	_	—	_	_					
19.2	20.833	8.51	2	—	_	_	—	_	_					
57.6	62.500	8.51	0	—	_	_	—	_	_					
115.2	62.500	-45.75	0	_	—	—	_		—					

		SYNC = 0, BRGH = 1, BRG16 = 0													
BAUD	Fosc = 40.000 MHz			Fosc = 20.000 MHz			Fosc = 10.000 MHz			Fosc = 8.000 MHz					
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)			
0.3	_									_					
1.2	—	—	—	—	—	—	—		—	—	—	—			
2.4	—	—	—	—	—	—	2.441	1.73	255	2.403	-0.16	207			
9.6	9.766	1.73	255	9.615	0.16	129	9.615	0.16	64	9.615	-0.16	51			
19.2	19.231	0.16	129	19.231	0.16	64	19.531	1.73	31	19.230	-0.16	25			
57.6	58.140	0.94	42	56.818	-1.36	21	56.818	-1.36	10	55.555	3.55	8			
115.2	113.636	-1.36	21	113.636	-1.36	10	125.000	8.51	4	—	_	_			

	SYNC = 0, BRGH = 1, BRG16 = 0									
BAUD	Fosc = 4.000 MHz			Fosc = 2.000 MHz			Fosc = 1.000 MHz			
(K)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	Actual Rate (K)	% Error	SPBRG value (decimal)	
0.3	_	_		_	_	_	0.300	-0.16	207	
1.2	1.202	0.16	207	1.201	-0.16	103	1.201	-0.16	51	
2.4	2.404	0.16	103	2.403	-0.16	51	2.403	-0.16	25	
9.6	9.615	0.16	25	9.615	-0.16	12	—	—	—	
19.2	19.231	0.16	12	—	_	_	—	_	_	
57.6	62.500	8.51	3	—	_	_	—	_	_	
115.2	125.000	8.51	1	_		_	_		_	

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15.2.4 AUTO-WAKE-UP ON SYNC BREAK CHARACTER

During Sleep mode, all clocks to the EUSART are suspended. Therefore, the Baud Rate Generator is inactive and proper byte reception cannot be performed. The auto-wake-up feature allows the controller to wake-up due to activity on the RX/DT line while the EUSART is operating in Asynchronous mode.

The auto-wake-up feature is enabled by setting the WUE bit (BAUDCON<1>). Once set, the typical receive sequence on RX/DT is disabled and the EUSART remains in an Idle state, monitoring for a wake-up event independent of the CPU mode. A wake-up event consists of a high-to-low transition on the RX/DT line. (This coincides with the start of a Sync Break or a Wake-up Signal character for the LIN protocol.)

Following a wake-up event, the module generates an RCIF interrupt. The interrupt is generated synchronously to the Q clocks in normal operating modes (Figure 15-8) and asynchronously if the device is in Sleep mode (Figure 15-9). The interrupt condition is cleared by reading the RCREG register.

The WUE bit is automatically cleared once a low-to-high transition is observed on the RX line following the wakeup event. At this point, the EUSART module is in Idle mode and returns to normal operation. This signals to the user that the Sync Break event is over.

15.2.4.1 Special Considerations Using Auto-Wake-up

Since auto-wake-up functions by sensing rising edge transitions on RX/DT, information with any state changes before the Stop bit may signal a false End-of-Character

(EOC) and cause data or framing errors. To work properly, therefore, the initial character in the transmission must be all '0's. This can be 00h (8 bits) for standard RS-232 devices or 000h (12 bits) for LIN bus.

Oscillator start-up time must also be considered, especially in applications using oscillators with longer start-up intervals (i.e., XT or HS mode). The Sync Break (or Wake-up Signal) character must be of sufficient length and be followed by a sufficient interval to allow enough time for the selected oscillator to start and provide proper initialization of the EUSART.

15.2.4.2 Special Considerations Using the WUE Bit

The timing of WUE and RCIF events may cause some confusion when it comes to determining the validity of received data. As noted, setting the WUE bit places the EUSART in an Idle mode. The wake-up event causes a receive interrupt by setting the RCIF bit. The WUE bit is cleared after this when a rising edge is seen on RX/ DT. The interrupt condition is then cleared by reading the RCREG register. Ordinarily, the data in RCREG will be dummy data and should be discarded.

The fact that the WUE bit has been cleared (or is still set) and the RCIF flag is set should not be used as an indicator of the integrity of the data in RCREG. Users should consider implementing a parallel method in firmware to verify received data integrity.

To assure that no actual data is lost, check the RCIDL bit to verify that a receive operation is not in process. If a receive operation is not occurring, the WUE bit may then be set just prior to entering the Sleep mode.

FIGURE 15-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING NORMAL OPERATION



FIGURE 15-9: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP



R/W-0	11-0	R/\\/-0	R/\\/_0	R/W-0	R/W/-0	R/W/-0	R/W-0				
	<u> </u>	ACOT2	ACOT1	ACOTO	ADCS2	ADCS1	ADCS0				
bit 7		NOQTZ	nouri	Nogio	710002	7,0001	bit 0				
Legend:											
R = Readable	e bit	W = Writable	bit	U = Unimpler	mented bit, read	l bit, read as '0'					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unknown					
bit 7	ADFM: A/D F	Result Format S	Select bit								
	1 = Right just 0 = Left justifi	ified ed									
bit 6	Unimplemen	ted: Read as '	0'								
bit 5-3	ACQT2:ACQ	T0: A/D Acquis	sition Time Se	lect bits							
	111 = 20 Tad										
	110 = 16 Tad										
	101 = 12 TAD										
	100 = 8 TAD										
	011 = 6 IAD										
	$0.01 = 2 T_{AD}$										
	000 = 0 TAD ⁽¹	I)									
bit 2-0	ADCS2:ADC	S0: A/D Conve	ersion Clock S	elect bits							
	111 = FRC (c	lock derived fro	om A/D RC os	cillator) ⁽¹⁾							
	110 = Fosc/6	64									
	101 = Fosc/1	16									
	100 = Fosc/4	ł		(4)							
	011 = FRC (cl	lock derived fro	om A/D RC os	cillator) ⁽¹⁾							
	010 = Fosc/3	32									
	001 = FOSC/8	5									
	000 - FOSC/2	<u></u>									

REGISTER 16-3: ADCON2: A/D CONTROL REGISTER 2

Note 1: If the A/D FRC clock source is selected, a delay of one TcY (instruction cycle) is added before the A/D clock starts. This allows the SLEEP instruction to be executed before starting a conversion.

17.2 HLVD Setup

The following steps are needed to set up the HLVD module:

- 1. Disable the module by clearing the HLVDEN bit (HLVDCON<4>).
- 2. Write the value to the HLVDL3:HLVDL0 bits that selects the desired HLVD trip point.
- Set the VDIRMAG bit to detect high voltage (VDIRMAG = 1) or low voltage (VDIRMAG = 0).
- 4. Enable the HLVD module by setting the HLVDEN bit.
- Clear the HLVD Interrupt Flag, HLVDIF (PIR2<2>), which may have been set from a previous interrupt.
- Enable the HLVD interrupt, if interrupts are desired, by setting the HLVDIE and GIE/GIEH bits (PIE2<2> and INTCON<7>). An interrupt will not be generated until the IRVST bit is set.

17.3 Current Consumption

When the module is enabled, the HLVD comparator and voltage divider are enabled and will consume static current. The total current consumption, when enabled, is specified in electrical specification parameter D022 (Section 270 "DC Characteristics"). Depending on the application, the HLVD module does not need to be operating constantly. To decrease the current requirements, the HLVD circuitry may only need to be enabled for short periods where the voltage is checked. After doing the check, the HLVD module may be disabled.

17.4 HLVD Start-up Time

The internal reference voltage of the HLVD module, specified in electrical specification parameter D420 (see Table 21-4 in **Section 21.0** "**Electrical Characteris-tics**"), may be used by other internal circuitry, such as the Programmable Brown-out Reset. If the HLVD or other circuits using the voltage reference are disabled to lower the device's current consumption, the reference voltage circuit will require time to become stable before a low or high-voltage condition can be reliably detected. This start-up time, TIRVST, is an interval that is independent of device clock speed. It is specified in electrical specification parameter 36 (Table 21-10).

The HLVD interrupt flag is not enabled until TIRVST has expired and a stable reference voltage is reached. For this reason, brief excursions beyond the set point may not be detected during this interval. Refer to Figure 17-2 or Figure 17-3.





NOTES:

18.4 Fail-Safe Clock Monitor

The Fail-Safe Clock Monitor (FSCM) allows the microcontroller to continue operation in the event of an external oscillator failure by automatically switching the device clock to the internal oscillator. The FSCM function is enabled by setting the FCMEN Configuration bit.

When FSCM is enabled, the INTRC oscillator runs at all times to monitor clocks to peripherals and provide a backup clock in the event of a clock failure. Clock monitoring (shown in Figure 18-3) is accomplished by creating a sample clock signal, which is the INTRC output divided by 64. This allows ample time between FSCM sample clocks for a peripheral clock edge to occur. The peripheral device clock and the sample clock are presented as inputs to the Clock Monitor latch (CM). The CM is set on the falling edge of the device clock source, but cleared on the rising edge of the sample clock.



Clock failure is tested for on the falling edge of the sample clock. If a sample clock falling edge occurs while CM is still set, a clock failure has been detected (Figure 18-4). This causes the following:

- the FSCM generates an oscillator fail interrupt by setting bit, OSCFIF (PIR2<7>);
- the device clock source is switched to the internal oscillator (OSCCON is not updated to show the current clock source – this is the fail-safe condition); and
- · the WDT is reset.

The FSCM will detect failures of the primary or secondary clock sources only. If the internal oscillator fails, no failure would be detected, nor would any action be possible.

18.4.1 FSCM AND THE WATCHDOG TIMER

Both the FSCM and the WDT are clocked by the INTRC oscillator. Since the WDT operates with a separate divider and counter, disabling the WDT has no effect on the operation of the INTRC oscillator when the FSCM is enabled.

If the WDT is enabled with a small prescale value, a decrease in clock speed allows a WDT time-out to occur and a subsequent device Reset. For this reason, Fail-Safe Clock Monitor events also reset the WDT and postscaler, allowing it to start timing from when execution speed was changed and decreasing the likelihood of an erroneous time-out.

18.4.2 EXITING FAIL-SAFE OPERATION

The fail-safe condition is terminated by either a device Reset or by entering a power-managed mode. On Reset, the controller starts the primary clock source specified in Configuration Register 1H (with any startup delays that are required for the oscillator mode, such as OST or PLL timer). The INTRC provides the device clock until the primary clock source becomes ready (similar to a Two-Speed Start-up). The clock source is then switched to the primary clock (indicated by the OSTS bit in the OSCCON register becoming set). The Fail-Safe Clock Monitor then resumes monitoring the peripheral clock.

The primary clock source may never become ready during start-up. In this case, operation is clocked by the INTRC. The OSCCON register will remain in its Reset state until a power-managed mode is entered.

FIGURE 19-1: GENERAL FORMAT FOR INSTRUCTIONS Byte-oriented file register operations **Example Instruction** 15 10 9 8 7 0 ADDWF MYREG, W, B OPCODE f (FILE #) d а d = 0 for result destination to be WREG register d = 1 for result destination to be file register (f) a = 0 to force Access Bank a = 1 for BSR to select bank f = 8-bit file register address Byte to Byte move operations (2-word) 15 12 11 0 OPCODE f (Source FILE #) MOVFF MYREG1, MYREG2 15 12 11 0 1111 f (Destination FILE #) f = 12-bit file register address Bit-oriented file register operations 987 15 12 11 0 OPCODE b (BIT #) a f (FILE #) BSF MYREG, bit, B b = 3-bit position of bit in file register (f) a = 0 to force Access Bank a = 1 for BSR to select bank f = 8-bit file register address Literal operations 15 8 7 0 OPCODE k (literal) MOVLW 7Fh k = 8-bit immediate value **Control** operations CALL, GOTO and Branch operations 15 8 7 0 n<7:0> (literal) GOTO Label OPCODE 15 12 11 0 1111 n<19:8> (literal) n = 20-bit immediate value 15 8 7 0 CALL MYFUNC OPCODE S n<7:0> (literal) 15 12 11 0 n<19:8> (literal) 1111 S = Fast bit 15 0 11 10 OPCODE n<10:0> (literal) BRA MYFUNC 15 8 7 0 BC MYFUNC OPCODE n<7:0> (literal)

	FIE	Return from	Return from Interrupt						
Syntax:		RETFIE {s	RETFIE {s}						
Operands:		$s \in [0,1]$	s ∈ [0,1]						
Ope	ration:	$(TOS) \rightarrow Pei$ $1 \rightarrow GIE/GI$ if s = 1, $(WS) \rightarrow W$, (STATUSS) $(BSRS) \rightarrow I$ PCLATU, P	$(TOS) \rightarrow PC,$ $1 \rightarrow GIE/GIEH \text{ or PEIE/GIEL};$ if $s = 1,$ $(WS) \rightarrow W,$ $(STATUSS) \rightarrow STATUS,$ $(BSRS) \rightarrow BSR,$ PCLATU, PCLATH are unchanged						
Statu	us Affected:	GIE/GIEH,	GIE/GIEH, PEIE/GIEL.						
Enco	oding:	0000	0000 0000 0001 00						
Desc	cription:	Return from and Top-of- the PC. Inte setting eithe global intern contents of STATUSS a their corres STATUS an of these reg	Return from interrupt. Stack is popped and Top-of-Stack (TOS) is loaded into the PC. Interrupts are enabled by setting either the high or low-priority global interrupt enable bit. If 's' = 1, the contents of the shadow registers WS, STATUSS and BSRS are loaded into their corresponding registers, W, STATUS and BSR. If 's' = 0, no update of these registers occurs (default)						
Word	ds:	1	1						
Cycl	es:	2							
QC	ycle Activity:								
	Q1	Q2	Q3		Q4				
	Decode	code No No operation			Рор	PC from			
		operation	operati	on	Set (stack GIEH or GIEL			
	No	No	No	on	Set (stack GIEH or GIEL No			
	No operation	No	No	on	Set (stack GIEH or GIEL No eration			

RET	LW	Return Literal to W							
Synta	ax:	RETLW k	RETLW k						
Oper	rands:	$0 \le k \le 255$							
Oper	ration:	$k \rightarrow W$, (TOS) $\rightarrow P$ PCLATU, P	$k \rightarrow W$, (TOS) \rightarrow PC, PCLATU, PCLATH are unchanged						
Statu	is Affected:	None							
Enco	oding:	0000	1100	kk}	k kkkk				
Desc	cription:	W is loaded with the 8-bit literal 'k'. T program counter is loaded from the t of the stack (the return address). The high address latch (PCLATH) remain unchanged.							
Word	ds:	1	1						
Cycle	es:	2	2						
QC	ycle Activity:								
	Q1	Q2	Q3	5		Q4			
	Decode	Read literal 'k'	Proce Data	ess a	Pop stac	PC from k, Write to W			
	No operation	No operation	No operat	ion	ор	No eration			
<u>Exan</u>	<u>nple:</u>								
	CALL TABLE	; W contains table ; offset value ; W now has ; table value							
	:								
'L'ART	LE	; W = offset ; Begin table ;							

:

RETLW kn ; End of table

07h

value of kn

Before Instruction W =

After Instruction W =

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TBLWT	Table Writ	e					
Syntax:	TBLWT (*; *+; *-; +*)						
Operands:	None						
Operation:	if TBLWT*, (TABLAT) \rightarrow Holding Register, TBLPTR – No Change; if TBLWT*+, (TABLAT) \rightarrow Holding Register, (TBLPTR) + 1 \rightarrow TBLPTR; if TBLWT*-, (TABLAT) \rightarrow Holding Register, (TBLPTR) – 1 \rightarrow TBLPTR; if TBLWT+*, (TBLPTR) + 1 \rightarrow TBLPTR, (TABLAT) \rightarrow Holding Register						
Status Affected:	None						
Encoding:	0000	0000	0000	11nn nn=0 * =1 *+ =2 *- =3 +*			
Description:	=3 +*This instruction uses the 3 LSBs of TBLPTRto determine which of the 8 holdingregisters the TABLAT is written to. Theholding registers are used to program thecontents of Program Memory (P.M.). (Referto Section 6.0 "Flash Program Memory"for additional details on programming Flashmemory.)The TBLPTR (a 21-bit pointer) points toeach byte in the program memory. TBLPTRhas a 2-Mbyte address range. The LSb ofthe TBLPTR selects which byte of theprogram memory location to access.TBLPTR<0> = 0: Least Significant Byte ofProgram Memory WordTBLPTR<0> = 1: Most Significant Byte ofProgram Memory WordThe TBLWT instruction can modify thevalue of TBLPTR as follows:• no change• post-increment• post-decrement						
Words:	1						
Cycles:	2						
Q Cycle Activity:							
	Q1	Q2	Q3	Q4			
	Decode	No operation	No operation	No operation			
	No	No	No	No			
	No No No No operation operation operation operation operation (Read TABLAT) Holding Reaister)						

TBLWT Table Write (Continued)

		-
Example 1: TBLWT *+;		
Before Instruction		
TABLAT	=	55h
TBLPTR	=	00A356h
HOLDING REGISTER	_	EEb
After Instructions (table write	-	lotion)
	- comp	55h
	=	00A357h
HOLDING REGISTER		
(00A356h)	=	55h
Example 2: TBLWT +*;		
Before Instruction		
TABLAT	=	34h
TBLPTR	=	01389Ah
HOLDING REGISTER (01380Ab)	_	FEb
HOLDING REGISTER	-	
(01389Bh)	=	FFh
After Instruction (table write	comple	etion)
TABLAT	=	34h
TBLPTR	=	01389Bh
HOLDING REGISTER	_	FEb
HOLDING REGISTER	-	
(01389Bh)	=	34h





TABLE 21-4: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

Operatir	ng temp	erature $-40^{\circ}C \le TA \le +8$	5°C for industrial					
Param No.	Sym	Charact	Characteristic			Max	Units	Conditions
D420		HLVD Voltage on VDD	HLVDL<3:0> = 0000	2.06	2.17	2.28	V	
		Transition High-to-Low	HLVDL<3:0> = 0001	2.12	2.23	2.34	V	
			HLVDL<3:0> = 0010	2.24	2.36	2.48	V	
			HLVDL<3:0> = 0011	2.32	2.44	2.56	V	
			HLVDL<3:0> = 0100	2.47	2.60	2.73	V	
			HLVDL<3:0> = 0101	2.65	2.79	2.93	V	
			HLVDL<3:0> = 0110	2.74	2.89	3.04	V	
			HLVDL<3:0> = 0111	2.96	3.12	3.28	V	
			HLVDL<3:0> = 1000	3.22	3.39	3.56	V	
			HLVDL<3:0> = 1001	3.37	3.55	3.73	V	
			HLVDL<3:0> = 1010	3.52	3.71	3.90	V	
			HLVDL<3:0> = 1011	3.70	3.90	4.10	V	
			HLVDL<3:0> = 1100	3.90	4.11	4.32	V	
			HLVDL<3:0> = 1101	4.11	4.33	4.55	V	
			HLVDL<3:0> = 1110	4.36	4.59	4.82	V	

Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for industrial